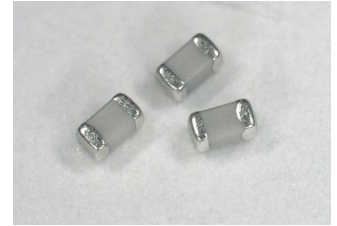


Specification

Part No.: 0201BB104KW160

0201BB (.020" x .010")



◆ Product Features

Typical Operating Frequency Range: 16KHz (-3dB) to >40GHz.

Insertion Loss: <1dB (typical).16WVDC.

Termination Type: Ni/Sn or Au.

Packaging Type: 15Kpcs/reel (15,000 units per reel).

◆ Product Application

Optoelectronics / High-Speed Data Transmission

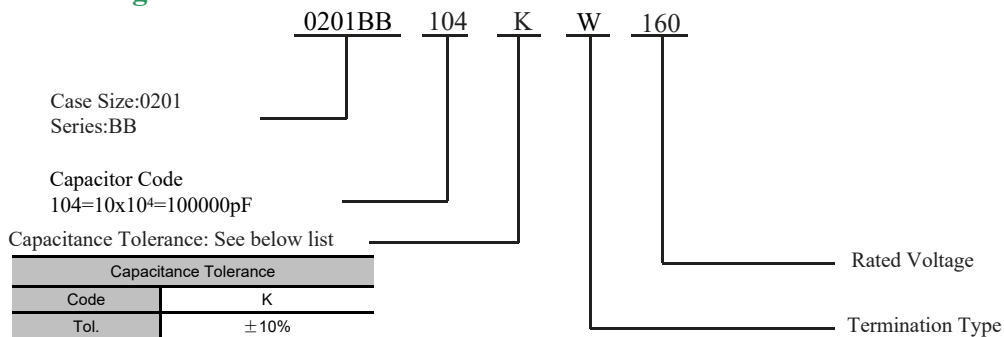
ROSA/TOSA (Receiver Optical Subassembly / Transmitter Optical Subassembly)

SONET (Synchronous Optical Networking)

Broadband Test Equipment

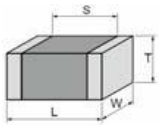
Broadband Microwave and Millimeter-Wave Amplifiers and Oscillator

◆ **Part Numbering**

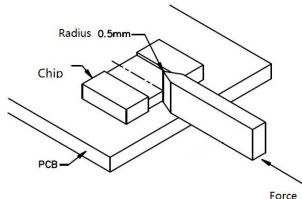


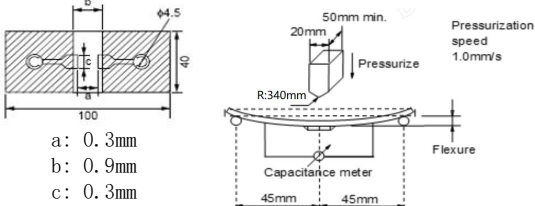
◆ **0201BB Termination Type and Dimensions**

unit: inch (millimeter)

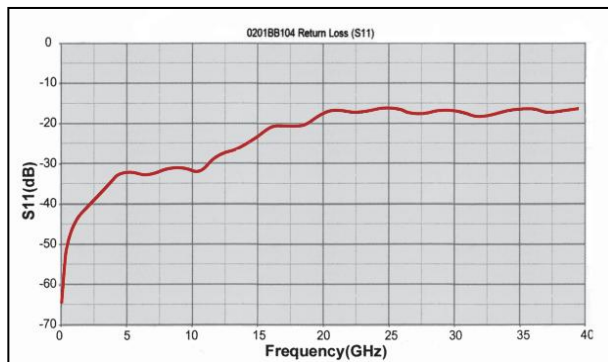
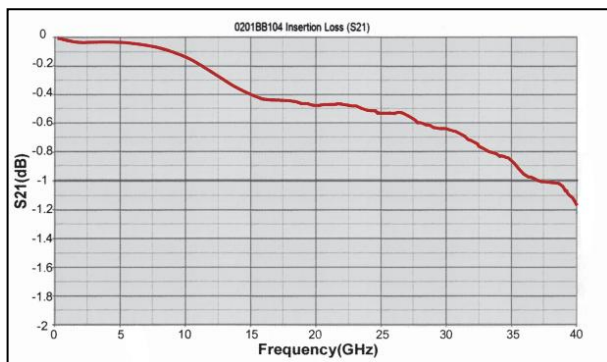
Series	Term. Code	Type/ Outlines	Capacitor Dimensions				Plated Material
			Length L	Width W	Thickness T	S	
0201BB	W		.023±.001 (0.58±0.03)	.012±.001 (0.30±0.03)	.0118 (0.30) max	.0078 (0.20) min	100%Sn over Nickel Plating , RoHS Compliant
	G						100%Au Plating

◆ **Reliability Test Conditions.**

No.	Item	Specification	Test method												
1	Operating temperature	-55°C~125°C													
2	Appearance	No defects or abnormality	Visual inspection: ×10 microscope.												
3	Dimensions	See the previous page	Caliper inspection												
4	Capacitance	Shall be within the applicable tolerance specified.	Test frequency: 1KHz±10% Test voltage: 1.0±0.2Vrms												
5	D.F	DF≤10%													
6	Insulation resistance	≥5G Ω	Voltage: DC Rated Voltage												
7	Dielectric withstanding voltage (DWV)	Shall be no evidence of breakdown or visible evidence of arcing or damage.	Test Voltage: 250% of the rated voltage Applied Time: 5 s Charge/discharge current: 50mA max.												
8	Temperature coefficient	Capacitance change is no more than ±15%.	The capacitance change should be measured after 5 min. at each specified temp. stage. Capacitance value as a reference is the value in step 3. <table><tr><td>step</td><td>temperature (°C)</td></tr><tr><td>1</td><td>25±2</td></tr><tr><td>2</td><td>-55±3</td></tr><tr><td>3</td><td>25±2</td></tr><tr><td>4</td><td>125±3</td></tr><tr><td>5</td><td>25±2</td></tr></table> $TC = \frac{C_x - C_3}{C_3 \times \Delta T} \times 100(\%)$	step	temperature (°C)	1	25±2	2	-55±3	3	25±2	4	125±3	5	25±2
step	temperature (°C)														
1	25±2														
2	-55±3														
3	25±2														
4	125±3														
5	25±2														
9	Adhesive Strength of Termination	No removal of the terminations or other defect should occur.	Pressurizing force:1.0^{+0.5}₀N Test time: 10±1 sec. 												

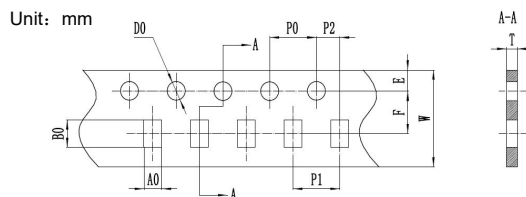
No.	Item	Specification	Test method															
10	Substrate Bending test	Appearance: No cracking shall occur. $\Delta C/C: \pm 12.5\%$	Mounting method: Reflow solder the capacitor on the test substrate. Pressurization Method: Shown as below. Flexure 1mm. Holding Time $5 \pm 1s$  a: 0.3mm b: 0.9mm c: 0.3mm Pressurization speed 1.0mm/s															
11	Solderability of termination	Shall be at least 95 percent covered with a smooth solder coating.	Immerse the capacitor in a eutectic solution requirement temperature $245 \pm 2^{\circ}C$ for 2 ± 0.5 seconds. Capacitor shall be immersed to a depth of 10mm.															
12	Resistance to soldering Heat	Appearance: No evidence of mechanical damage or delamination or exposed. Cap change: within $\pm 12.5\%$; D.F: To meet initial requirement. IR($25^{\circ}C$): To meet initial requirement.	Preheat for 1 minute at $150^{\circ}C$ to $180^{\circ}C$ before immerse the capacitor in a eutectic solution at $260 \pm 5^{\circ}C$ for 10 ± 1 seconds. Capacitor shall be immersed to a depth of 10mm. And following a 24 ± 2 hours cooling period.															
13	Temperature Cycle	Appearance: No evidence of mechanical damage . Cap change: within $\pm 10\%$.. D.F: To meet initial requirement. IR($25^{\circ}C$): No less than 30% initial requirement. DWV: To meet initial requirement.	Perform the 5 cycles according to the four heat treatments listed in the following table. Set it for 24 ± 2 hours at room temperature. <table><tr><th>step</th><th>Temperature($^{\circ}C$)</th><th>Time(Min)</th></tr><tr><td>1</td><td>-55(-3~0)</td><td>≥ 30</td></tr><tr><td>2</td><td>25 ± 10</td><td>≤ 5</td></tr><tr><td>3</td><td>$125(0 \sim +3)$</td><td>≥ 30</td></tr><tr><td>4</td><td>25 ± 10</td><td>≤ 5</td></tr></table>	step	Temperature($^{\circ}C$)	Time(Min)	1	-55(-3~0)	≥ 30	2	25 ± 10	≤ 5	3	$125(0 \sim +3)$	≥ 30	4	25 ± 10	≤ 5
step	Temperature($^{\circ}C$)	Time(Min)																
1	-55(-3~0)	≥ 30																
2	25 ± 10	≤ 5																
3	$125(0 \sim +3)$	≥ 30																
4	25 ± 10	≤ 5																
14	Humidity, steady state	Appearance: No evidence of mechanical damage . Cap change: within $\pm 12.5\%$ IR($25^{\circ}C$): $\geq 12.5\Omega \cdot F$ D.F: $\leq 20\%$	With (1.3 ± 0.25) Volts D.C. applied while subjected to an environment of $85^{\circ}C$ with 85% relative humidity for 240 hours minimum. Removed and sit 3.5 ± 0.5 hours at room temperature.															
15	High Temperature Load (Life)	Appearance: No evidence of mechanical damage . Cap change: within $\pm 12.5\%$; D.F: $\leq 20\%$. IR: $\geq 25\Omega \cdot F$	Test Voltage: 150% of the rated voltage The charge/discharge current is less than 50mA. Temperature: $125^{\circ}C$; Time: 1000h. Measurement: Set it for 48 hours at room temperature, then measure.															

◆ 0201BB Performance Curve

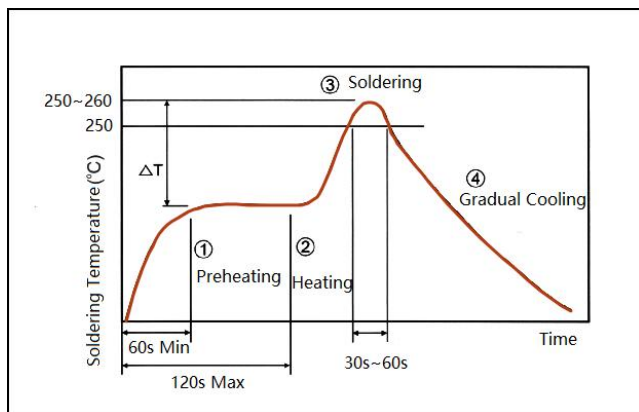


◆ Tape & Reel Specifications

EIA	A0	B0	W	P0	P1	T	F	Qty/reel	Tape Material
0201	0.40	0.70	8.00	4.00	2.00	0.42	3.50	15000	Paper



◆ Recommended soldering conditions



$\Delta T \leq 190^{\circ}\text{C}$;
Maximum temperature: $255^{\circ}\text{C} \pm 5^{\circ}\text{C}$;
Heating rate: $\leq 4^{\circ}\text{C/s}$.

◆ Recommended Land Dimensions

EIA	A(mm)	B(mm)	C(mm)
0201	0.20-0.30	0.20-0.35	0.20-0.40

